



Synamic9GN

Halogen free extremely low loss multilayer PCB base material

FEATURES

- Extremely low Dk/Df(@10GHz): 3.34/0.0014
- High Tg, 210°C by DMA
- Higher heat resistance Td: >400°C, T288>60min
- Lower Z-axis CTE, offering superior PTH reliability
- Lower moisture absorption with excellent resistance against moisture and heat

APPLICATIONS

- Ultra-high speed network equipment (112G)
- AI server, switch, storage, routers and BBU of base station, etc.
- Super computing
- High frequency measuring instruments etc.

GENERAL PROPERTIES

Test Items	Test Method	Test Condition	Unit	Typical Value
Tg	IPC-TM-650 2.4.24.2	DMA	°C	210
	IPC-TM-650 2.4.24.1	TMA		180
Td	IPC-TM-650 2.4.24.6	5% wt. loss	°C	400
T288	IPC-TM-650 2.4.24.1	TMA	min	>60
T300	IPC-TM-650 2.4.24.1	TMA	min	>60
Thermal Stress	IPC-TM-650 2.4.13.1	288°C, solder dipping	-	Pass
X/Y-CTE	IPC-TM-650 2.4.24.5	TMA(30~120°C)	ppm/°C	12/13
CTE (Z-axis)	IPC-TM-650 2.4.24	Before Tg	ppm/°C	40
	IPC-TM-650 2.4.24	After Tg	ppm/°C	140
	IPC-TM-650 2.4.24	50-260°C	%	1.5
Dielectric Constant (Dk)	IPC-TM-650 2.5.5.9 (1GHz)	C-24/23/50	-	3.25
	IEC61189-2-721 (10GHz)	C-24/23/50	-	3.34
	BCDR (14GHz)	C-24/23/50	-	3.15
Dissipation Factor (Df)	IPC-TM-650 2.5.5.9 (1GHz)	C-24/23/50	-	0.0005
	IEC61189-2-721 (10GHz)	C-24/23/50	-	0.0014
	BCDR (14GHz)	C-24/23/50	-	0.0014
Peel Strength (1 oz)	IPC-TM-650 2.4.8	288°C/10s	N/mm	0.53
Water Absorption	IPC-TM-650 2.6.2.1	D-24/23	%	0.06
Flammability	UL94	C-48/23/50	Rating	V-0

Remarks:

1. All the typical value is based on the 0.76mm (10*1078 RC66%) thickness specimen, but not guarantee data.
2. All the typical value listed above is for your reference only, please turn to Shengyi Technology Co., Ltd. for detailed information, and all rights from this data sheet are reserved by Shengyi Technology Co., Ltd.